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## Advancements in Signal Processing: Communications, Sensing and Imaging

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### Message from the Guest Editors

This Special Issue will include, but is not limited to, the application of digital twin technologies to address the following areas:

- Advanced communication systems and networks, including 5G/6G and beyond;
- Machine learning and other AI topics in signal processing for communications, sensing, and imaging;
- Signal processing techniques for wireless communications;
- Sensing technologies for smart environments and IoT applications;
- Innovative imaging techniques, including medical and industrial applications;
- Noise reduction, filtering, and signal enhancement methods;
- Data fusion techniques for multi-sensor systems;
- Security and privacy issues in communication and sensing systems;
- Signal processing for biomedical applications, including imaging and wearable sensors;
- Advances in optical and quantum signal processing;
- Visible Light Communications (VLCs) and Optical Camera Communications (OCCs);
- Adaptive systems and multimedia applications;
- Software-defined networking and network data analytics;
- Precision agriculture and environmental
- Power-efficient circuits for signal processing,

# Special Issue



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## Message from the Editor-in-Chief

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